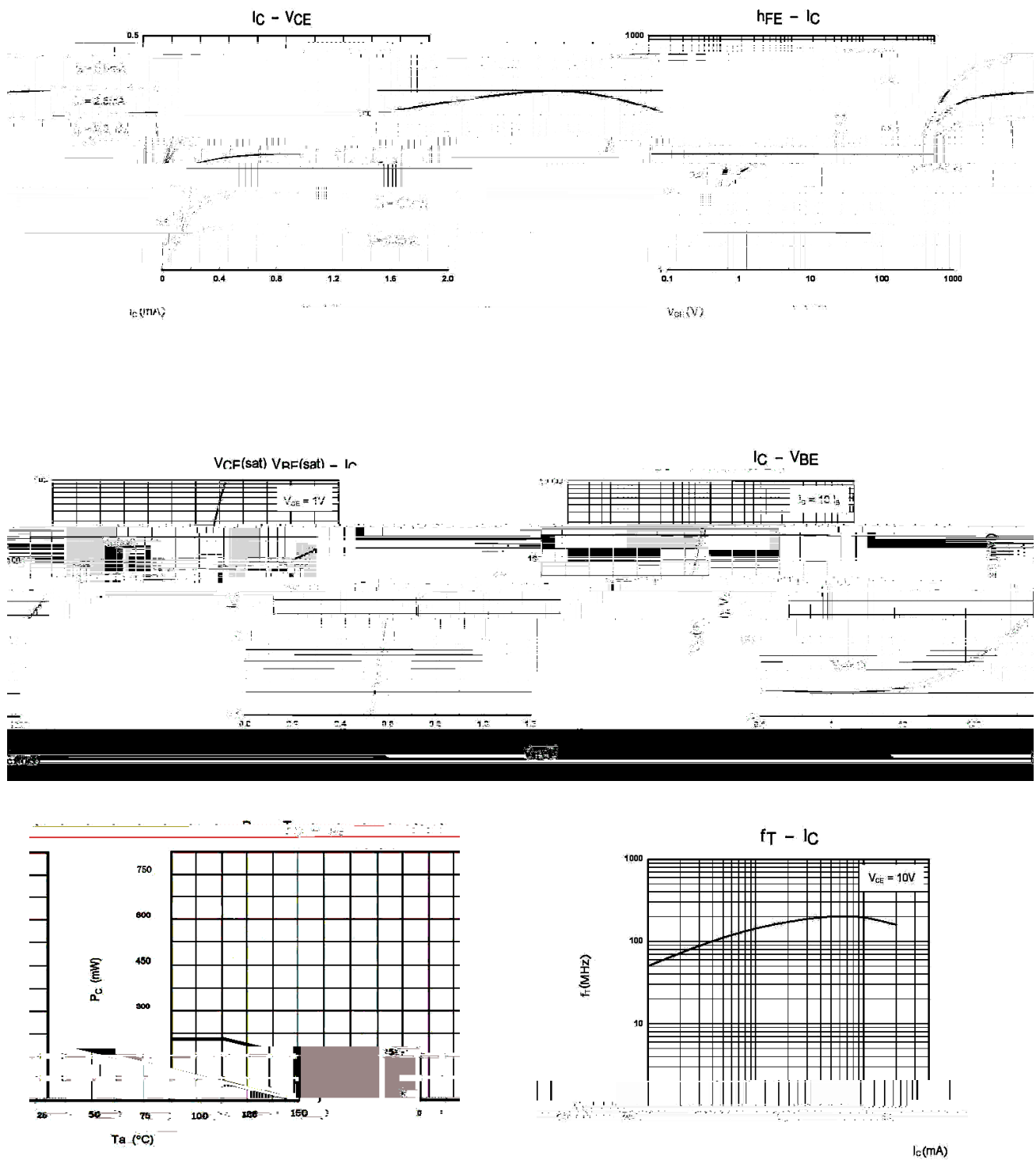
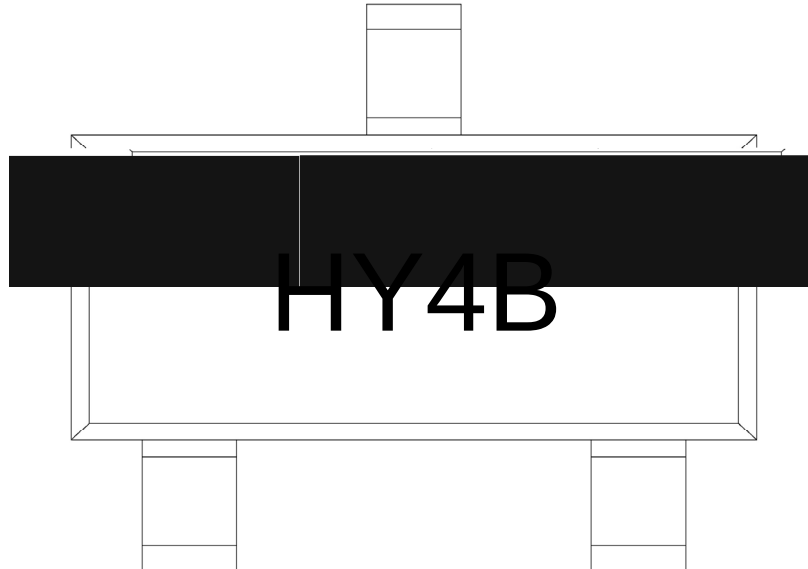


Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	-40	V
Collector to Emitter Voltage	V_{CEO}	-25	V
Emitter to Base Voltage	V_{EBO}	-6.0	V
Collector Current	I_C	-800	mA
Base Current	I_B	-200	mA
Collector Power Dissipation	P_C	200	mW
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-65 150	

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector to Base Breakdown Voltage	V_{CBO}	$I_C = -0.1mA$ $I_E = 0$	-40			V
Collector to Emitter Breakdown Voltage	V_{CEO}	$I_C = -2.0mA$ $I_B = 0$	-25			V
Emitter to Base Breakdown Voltage	V_{EBO}	$I_E = -0.1mA$ $I_C = 0$	-6.0			V
Collector Cut-Off Current	I_{CBO}	$V_{CB} = -35V$ $I_E = 0$			-0.1	μA
Emitter Cut-Off Current	I_{EBO}	$V_{EB} = -6.0V$ $I_C = 0$			-0.1	μA
DC Current Gain	$h_{FE(1)}$	$V_{CE} = -1.0V$ $I_C = -100mA$	85		300	
	$h_{FE(2)}$	$V_{CE} = -1.0V$ $I_C = -500mA$	40			
	$h_{FE(3)}$	$V_{CE} = -1.0V$ $I_C = -5.0mA$	45			
Collector-emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = -500mA$ $I_B = -50mA$		-0.28	-0.6	V
Base-Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C = -500mA$ $I_B = -50mA$		-0.98	-1.2	V
Base-Emitter Voltage	V_{BE}	$V_{CE} = -1.0V$ $I_C = -10mA$		-0.66	-1.0	V
Transition Frequency	f_T	$V_{CE} = -10V$ $I_C = -50mA$	100	200		MHz
Collector Output Capacitance	C_{ob}	$V_{CB} = -10V$ $I_E = 0$ $f = 1.0MHz$		15		pF





H

Y4

B h_{FE}

Note:

H Company Code

Y4 Product Type Code

B h_{FE} Classifications Symbol Code

Temperature Profile for IR Reflow Soldering(Pb-Free)

Note:

- 1

150 180

60 90sec;

1.Preheating:150~180 , Time:60~90sec.
- 2

245±5

5±0.5sec;

2.Peak Temp.:245±5 , Duration:5±0.5sec.
- 3

2 10

/sec.

3. Cooling Speed: 2~10 /sec.

260±5

10±1 sec.

Temp.:260±5

Time:10±1 sec

/ REEL

Package Type	Units					Dimension			(unit mm ³)
	Units/Reel	Reels/Inner Box	Units/Inner Box	Inner Boxes/Outer Box	Units/Outer Box	Reel	Inner Box	Outer Box	